

SEMICONDUCTOR®

November 2013

FQP34N20

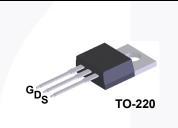
N-Channel QFET[®] MOSFET 200 V, 31 A, 75 m Ω

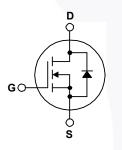
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 31 A, 200 V, $R_{DS(on)}$ = 75 m Ω (Max.) @ V_{GS} = 10 V, I_D = 15.5 A
- Low Gate Charge (Typ. 60 nC)
- Low Crss (Typ. 55 pF)
- 100% Avalanche Tested





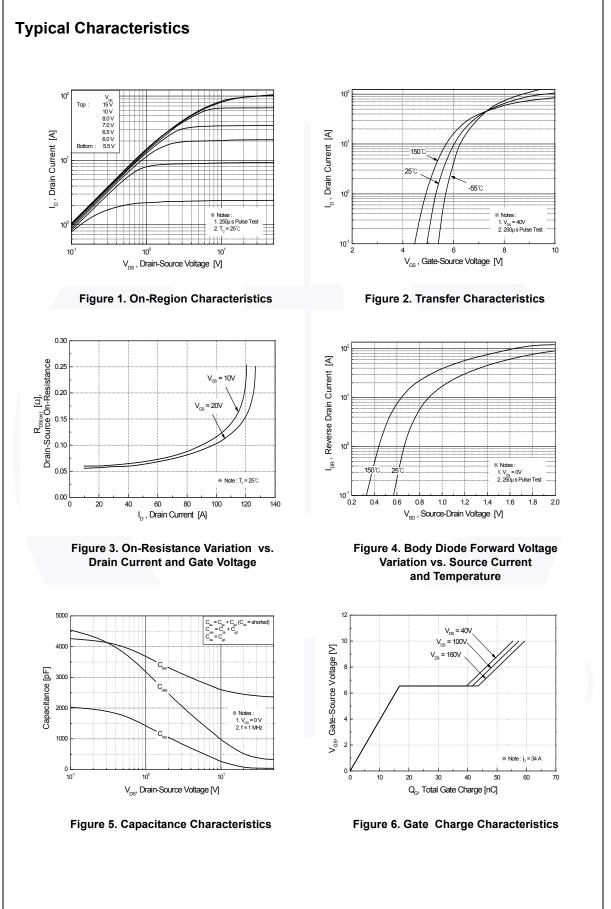
Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

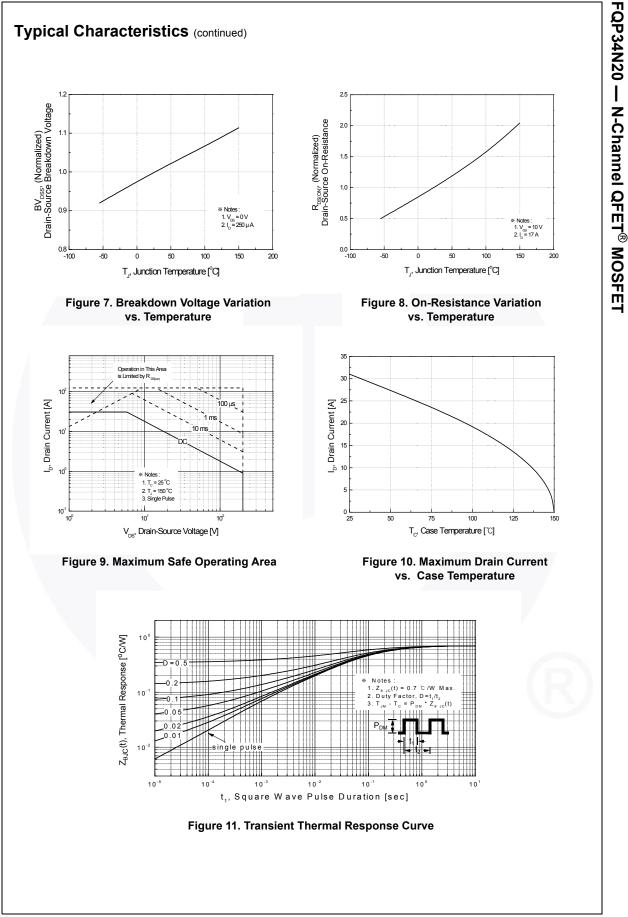
Symbol	Parameter		FQP34N20	Unit
V _{DSS}	Drain-Source Voltage		200	V
I _D	Drain Current - Continuous (T _C = 25°C	C)	31	A
	- Continuous (T _C = 100°	°C)	20	A
I _{DM}	Drain Current - Pulsed	(Note 1)	124	A
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	640	mJ
I _{AR}	Avalanche Current	(Note 1)	31	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	18	mJ
dv/dt	Peak Diode Recovery dv/dt	iode Recovery dv/dt (Note 3) 5.5		V/ns
P _D	Power Dissipation (T _C = 25°C)		180	W
	- Derate above 25°C		1.43	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

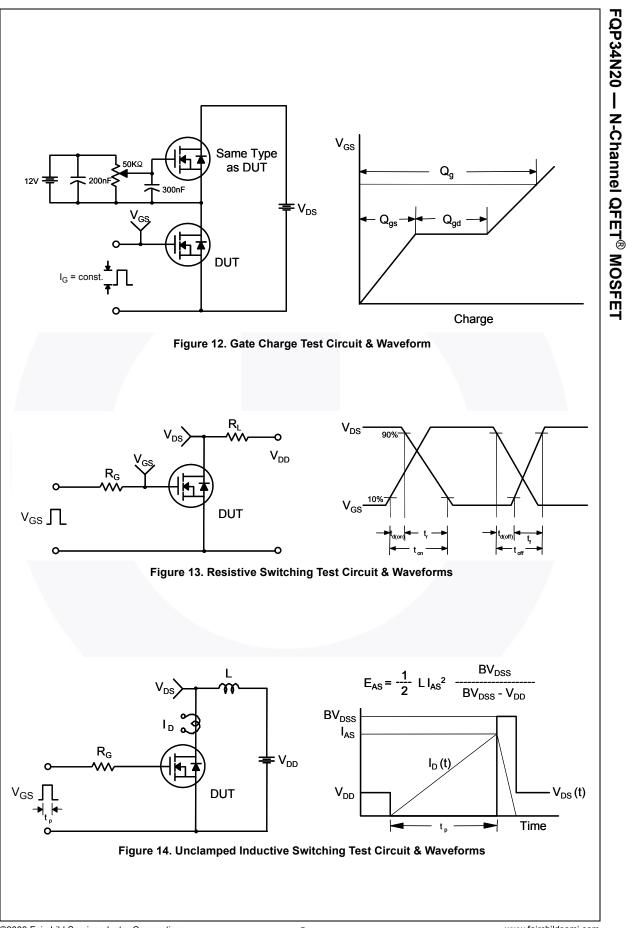
Thermal Characteristics

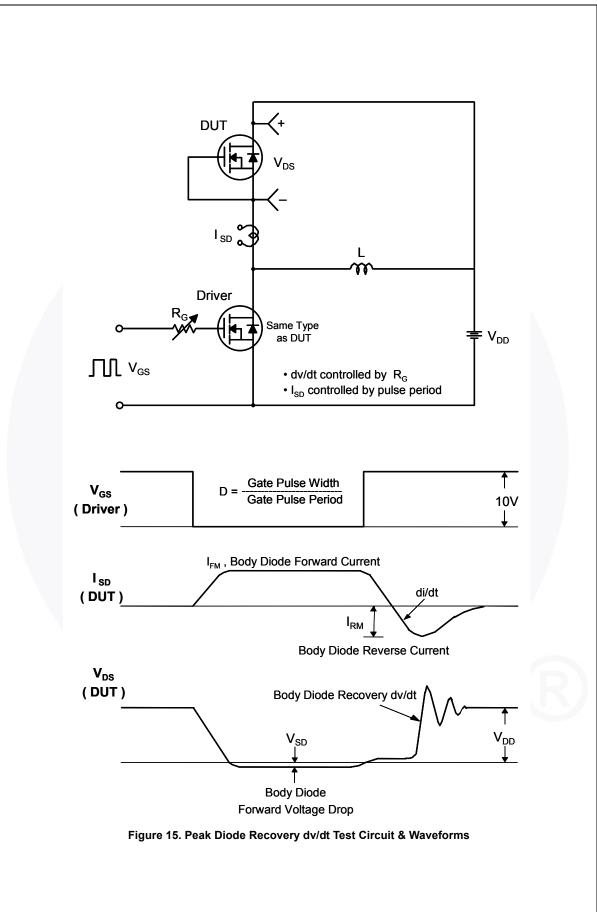
Symbol	Parameter	FQP34N20	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	0.7	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W	

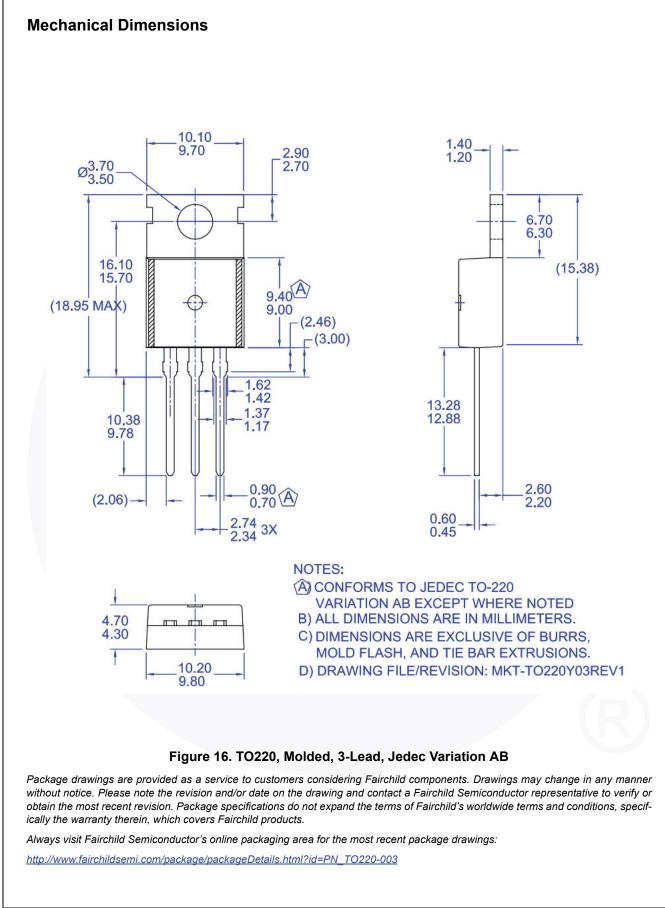
		Package	•		e Tape V		th C	Quantity 50 units	
FQP34	FQP34N20 FQP34N20 TO-220					N/A			
lectri	cal Cl	haracteristics	T _C = 25°C	unless otherwise noted.					
Symbol		Parameter		Test Cond	ditions	Min	Тур	Max	Unit
Off Cha	ractor	victics							
BV _{DSS}	1	Source Breakdown V		V _{GS} = 0 V, I _D = 25	ΟμΑ	200			V
BV _{DSS}			-			200			v
ΔT_{J}	Breakdown Voltage Temperature Coefficient		$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$			0.2		V/°C	
oss	Zara Oata Malta na Duain Orimant		mant	V_{DS} = 200 V, V_{GS}				1	μA
	Zero	Zero Gate Voltage Drain Current		V _{DS} = 160 V, T _C = 125°C				10	μA
GSSF	Gate-E	Body Leakage Curren	t, Forward	V_{GS} = 30 V, V_{DS} =	0 V			100	nA
GSSR	Gate-E	Body Leakage Curren	t, Reverse	V_{GS} = -30 V, V_{DS} =	= 0 V			-100	nA
On Cha	racter	istics							
GS(th)		hreshold Voltage		$V_{DS} = V_{GS}, I_{D} = 28$	50 μA	3.0		5.0	V
R _{DS(on)}	Static	Drain-Source		V _{GS} = 10 V, I _D = 1			0.06	0.075	Ω
FS		rd Transconductance		V _{DS} = 40 V, I _D = 1	5.5 A		25		S
viss	Input 0	racteristics Capacitance t Capacitance		$V_{\rm DS} = 25 \text{ V}, \text{ V}_{\rm GS} = 0 \text{ V},$			2400 430	3100 560	pF pF
Yoss				f = 1.0 MHz					
rss	Revers	se Transfer Capacitar	ice				55	70	pF
Switchi	ing Ch	aracteristics							
d(on)	Turn-C	On Delay Time		V _{DD} = 100 V, I _D =	34 Δ		40	90	ns
•	Turn-C	In Rise Time		$R_{\rm D} = 25 \Omega$	J - A,		280	570	ns
d(off)	Turn-C	Off Delay Time		116 20 32			125	260	ns
	Turn-C	Off Fall Time					115	240	ns
λ ^g	Total G	Bate Charge		V _{DS} = 160 V, I _D = 3	34 A,		60	78	nC
λ _{gs}	Gate-S	Source Charge		$V_{GS} = 10 V$			17		nC
۵ _{gd}	Gate-E	Drain Charge					27		nC
	ouroo	Diada Characta	rictico on	d Movimum P	tingo				
3	1	Diode Characte			-			31	Α
SM	Maxim	um Pulsed Drain-Sou	Irce Diode F	orward Current				124	А
/ _{SD}		Source Diode Forwar		V _{GS} = 0 V, I _S = 31	A			1.5	V
т		se Recovery Time	Ũ	$V_{GS} = 0 V, I_S = 34$			150		ns
ς Σ ^{ur}		se Recovery Charge		dl _F / dt = 100 A/µs			0.95		μC
tes:	1	, 0				1	I.	1	













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